



CUSTOMER NAME		TI		ASSEMBLY TOP		
BOARD NAME			DESCRIPTION			
TIDA-0890 USB Type-A Plug to USB Type-C(TM) Receptacle SS MUX with DFP Controller Reference Design			SILKSCREEN TOP			
BOARD NO.	REV	DATE	PRJ#	SH	OF	
	A1	13 NOV 2015	TIDA-00890	9	13	



CUSTOMER NAME		TI		ASSEMBLY BOTTOM		
BOARD NAME			DESCRIPTION			
TIDA-0890 USB Type-A Plug to USB Type-C(TM) Receptacle SS MUX with DFP Controller Reference Design			SILKSCREEN BOTTOM			
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